

1A Low Dropout Linear Regulator

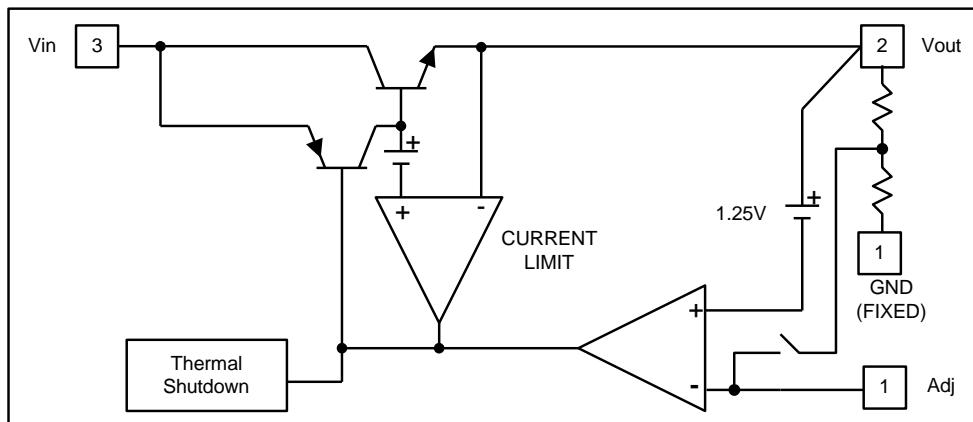
❖ GENERAL DESCRIPTION

AX1117A is a low dropout positive adjustable or fixed-mode regulator with minimum of 1A output current capability. The product is specifically designed to provide well-regulated supply for low voltage IC applications such as high-speed bus termination and low current 3.3V logic supply. AX1117A is also well suited for other applications such as VGA cards. AX1117A is guaranteed to have lower than 1.4V dropout at full load current making it ideal to provide well-regulated outputs of 1.25 to 5.0 with 6.4V to 12V input supply.

❖ FEATURES

- 1.5V maximum dropout at full load current
- Fast transient response
- Output current limiting
- Built-in thermal shutdown
- Good noise rejection
- Low-ESR Ceramic Capacitor (MLCC) Required for Stability.
- 3-Terminal Adjustable or Fixed 1.5V, 1.8V, 2.5V, 3.3V, 5.0V
- Packages: SOT223, TO252.
- RoHS and Halogen free compliance

❖ BLOCK DIAGRAM



❖ PIN ASSIGNMENT

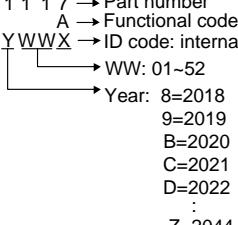
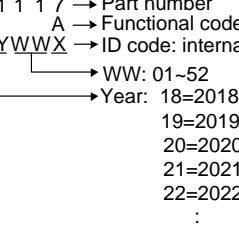
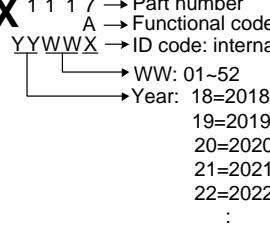
The packages of AX1117A are SOT223 and TO252; the pin assignment is given by:

SOT223 (Top View)		Name	Description
3	V _{IN}	Adj (GND)	A resistor divider from this pin to the V _{OUT} pin and ground sets the output voltage. (Ground only for Fixed-Mode)
2	V _{OUT}	Tab is V _{OUT}	
1	Adj (GND)		

TO252 (Top View)		Name	Description
3	V _{IN}	V _{OUT}	The output of the regulator. A minimum of 3.3uF EL capacitor (10mΩ ≤ ESR ≤ 1Ω) must be connected from this pin to ground to insure stability.(Note)
2	V _{OUT}	Tab is V _{OUT}	
1	Adj (GND)		

Note: To prevent oscillation, a 4.7uF minimum Y5V or a 1uF minimum X7R or X5R dielectric is strongly recommended if ceramics are used as input/output capacitors.

❖ ORDER/MARKING INFORMATION

Order Information			
AX 1117A X XX X Low Dropout Regulator Package V _{OUT} Packing E : SOT223-3L Blank : ADJ Blank : Tube D : TO252-3L 15 : 1.5V A : Taping 18 : 1.8V 25 : 2.5V 33 : 3.3V 50 : 5.0V			
Top Marking (SOT223-3L)		Top Marking (TO252-3L)	
ADJ Logo ← AX 1117 → Part number A → Functional code YYWWX → ID code: internal  FIX Output Voltage ← AX 1117 AX1117A-15: 1.5V A - VV AX1117A-18: 1.8V Y WWX → ID code: internal AX1117A-25: 2.5V AX1117A-33: 3.3V AX1117A-50: 5.0V  FIX Output Voltage ← AX 1117 AX1117A-15: 1.5V AX1117A-18: 1.8V AX1117A-25: 2.5V AX1117A-33: 3.3V AX1117A-50: 5.0V		ADJ Logo ← AX 1117 → Part number A → Functional code YYWWX → ID code: internal  FIX Output Voltage ← AX 1117 AX1117A-15: 1.5V AX1117A-18: 1.8V AX1117A-25: 2.5V AX1117A-33: 3.3V AX1117A-50: 5.0V	

❖ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating	Unit
DC Supply Voltage	V _{IN}	-0.3 to 15	V
Operating Junction Temperature Range	T _{OP}	-40 to +125	°C
Maximum junction Temperature	T _{MJ}	150	°C
Power Dissipation(No heat sink ;No air flow) T _A =25°C, T _J =125°C	SOT-223	850	mW
	TO-252	1050	
Storage Temperature	T _{ST}	-65 to +150	°C

❖ ELECTRICAL CHARACTERISTICS

(T_A=25°C, Under Operating Conditions)

Characteristics	Conditions	Min	Typ	Max	Units
Operation Input Voltage		2.75	-	12	V
Reference Voltage	AX1117A-ADJ T _J =25°C, (V _{IN-OUT}) =1.5V I _{OUT} =10mA	1.225	1.250	1.275	V
Output Voltage	AX1117A-1.5 I _{OUT} = 10mA, T _J = 25°C, 3V ≤ V _{IN} ≤ 12V	1.470	1.500	1.530	V
	AX1117A-1.8 I _{OUT} = 10mA, T _J = 25°C, 3.3V ≤ V _{IN} ≤ 12V	1.764	1.800	1.836	V
	AX1117A-2.5 I _{OUT} = 10mA, T _J = 25°C, 4V ≤ V _{IN} ≤ 12V	2.450	2.500	2.550	V
	AX1117A-3.3 I _{OUT} = 10mA, T _J = 25°C, 4.8V ≤ V _{IN} ≤ 12V	3.235	3.300	3.365	V
	AX1117A-5.0 I _{OUT} = 10mA, T _J = 25°C, 6.5V ≤ V _{IN} ≤ 12V	4.900	5.000	5.100	V
Line Regulation	AX1117A-XXX I _{OUT} =10mA, V _{OUT} +1.5V < V _{IN} < 12V, T _J =25°C (Note 1,2)	-	0.2	0.5	%
Load Regulation	AX1117A-ADJ V _{IN} =3.3V, V _{adj} =10mA < I _{OUT} < 1A, T _J =25°C (Note 1,2)	-	0.4	1	%
	AX1117A-1.5 V _{IN} =3V, 10mA < I _{OUT} < 1A, T _J =25°C (Note 1,2)	-	12	15	mV
	AX1117A-1.8 V _{IN} =3.3V, 10mA < I _{OUT} < 1A, T _J =25°C (Note 1,2)	-	15	18	mV

❖ ELECTRICAL CHARACTERISTICS (CONTINUOUS)

($T_A=25^\circ\text{C}$, Under Operating Conditions)

Characteristics	Conditions	Min	Typ	Max	Units	Characteristics
Load Regulation	AX1117A-2.5	$V_{IN}=4V$, $10\text{mA} < I_{OUT} < 1\text{A}$, $T_J=25^\circ\text{C}$ (Note 1,2)	-	20	25	mV
	AX1117A-3.3	$V_{IN}=5V$, $10\text{ mA} \leq I_{OUT} \leq 1\text{ A}$, $T_J=25^\circ\text{C}$ (Note 1,2)	-	26	33	mV
	AX1117A-5.0	$V_{IN}=6.5V$, $10\text{ mA} \leq I_{OUT} \leq 1\text{ A}$, $T_J=25^\circ\text{C}$ (Note 1,2)	-	40	50	mV
Dropout Voltage ($V_{IN}-V_{OUT}$)	AX1117A-ADJ /1.5/1.8/2.5/3.3/5.0	$I_{OUT}=1\text{A}$, $\Delta V_{OUT}=1\%V_{OUT}$	-	1.3	1.5	V
Current Limit	AX1117A-ADJ /1.5/1.8/2.5/3.3/5.0	$(V_{IN}-V_{OUT})=3V$	1. 1	-	-	A
Minimum Load Current	AX1117A-XXX	$0^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$	-	5	7	mA
Ripple Rejection	F=120Hz, $C_{OUT}=10\mu\text{f}$, $4.7\mu\text{f}$, $3.3\mu\text{f}$					
	AX1117A-XXX	$V_{IN}=V_{OUT}+3V$	50	60	70	dB
Temperature Stability	$I_{OUT}=10\text{mA}$		-	0.5	-	%
θ_{JA} Thermal Resistance Junction-to-Ambient (No heat sink ;No air flow)	SOT-223 TO-252		-	117 92	-	°C/W
θ_{JC} Thermal Resistance Junction-to-Case	SOT-223 TO-252		-	15 10	-	°C/W

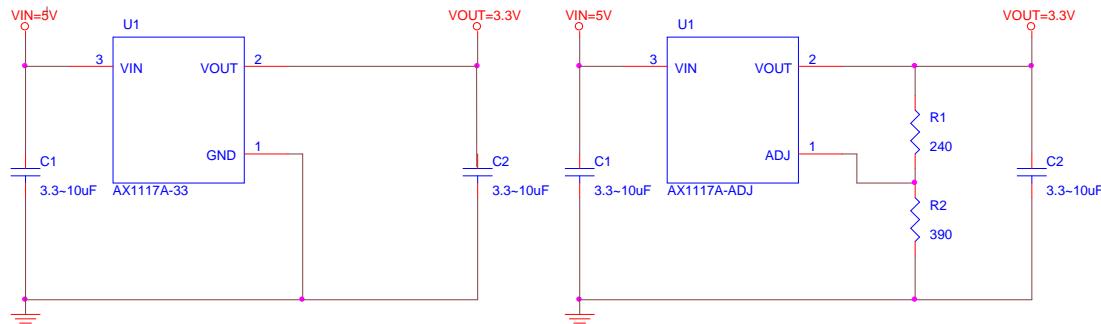
Note1: See thermal regulation specifications for changes in output voltage due to heating effects. Line and load regulation are measured at a constant junction temperature by low duty cycle pulse testing. Load regulation is measured at the output lead = 1/16" from the package.

Note2: Line and load regulation are guaranteed up to the maximum power dissipation of 15W. Power dissipation is determined by the difference between input and output differential and the output current. Guaranteed maximum power dissipation will not be available over the full input/output range.

Note3: Quiescent current is defined as the minimum output current required in maintaining regulation. At 12V input/output differential the device is guaranteed to regulate if the output current is greater than 10mA.

❖ APPLICATION CIRCUIT

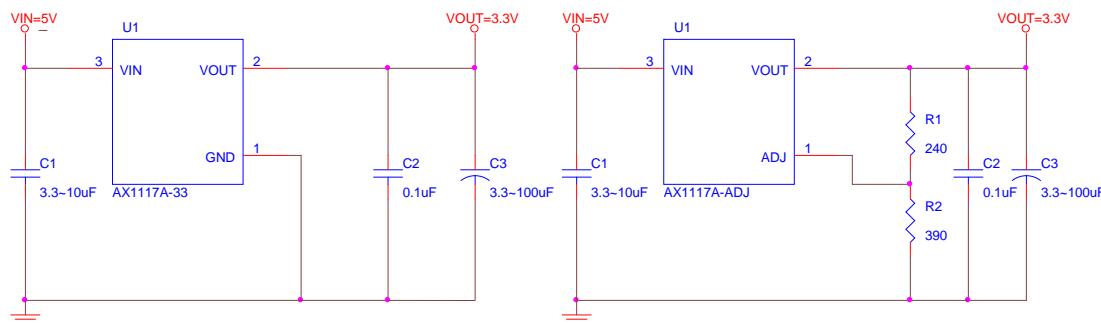
(1) Using Multilayer Ceramic Capacitor (MLCC) Fixed Output



$$V_{OUT} = V_{REF} \times (1 + \frac{R2}{R1}); V_{REF} = 1.250V$$

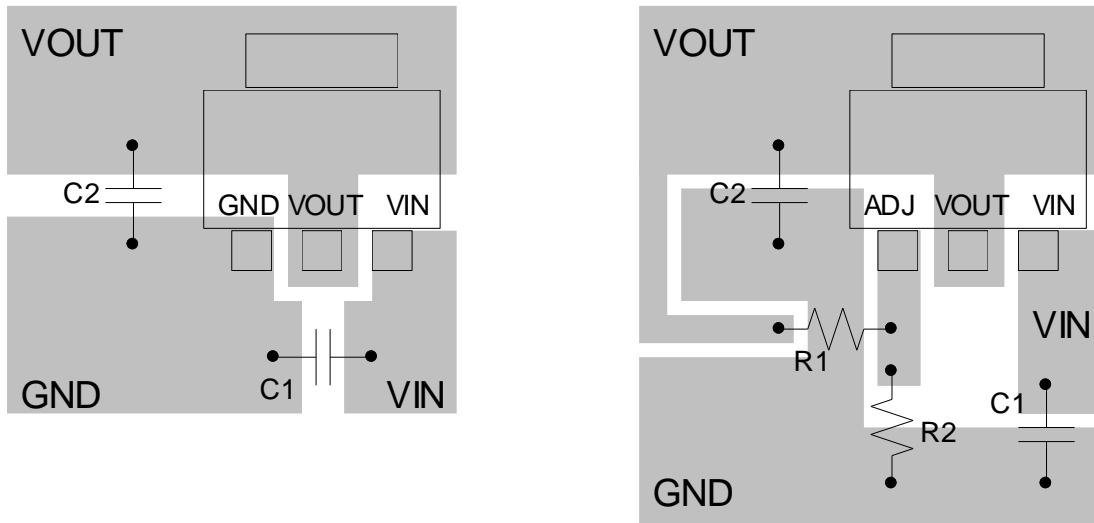
(2) Using Aluminum Electrolytic Capacitor (AL)

Fixed Output



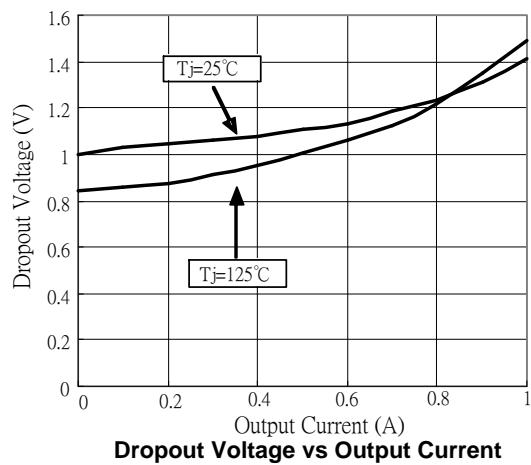
$$V_{OUT} = V_{REF} \times (1 + \frac{R2}{R1}); V_{REF} = 1.250V$$

Layout Guide

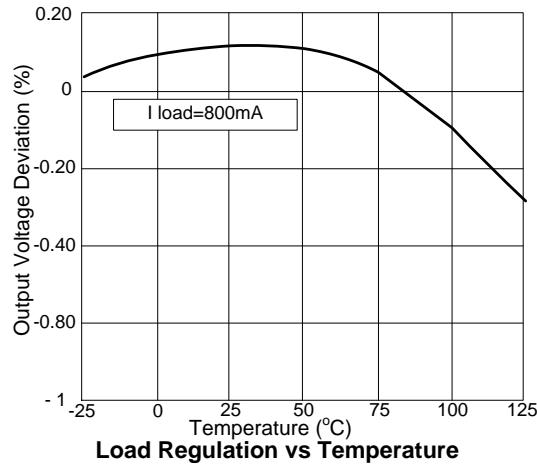


Best performance is achieved by placing C1 and C2 on the same side of the PCB as the AX1117A, and as close as is practical to the package. The ground connections for C1 and C2 should be back to the AX1117A ground plane using as wide, and as short, of a copper trace as is practical. To ensure the device does not overheat, connect the pad to VOUT plane with an appropriate amount of copper PCB area.

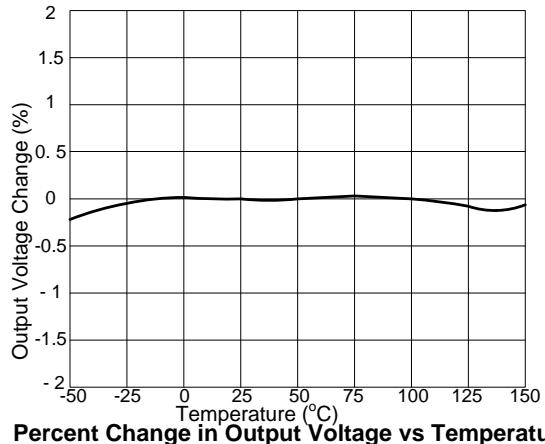
❖ TYPICAL CHARACTERISTICS



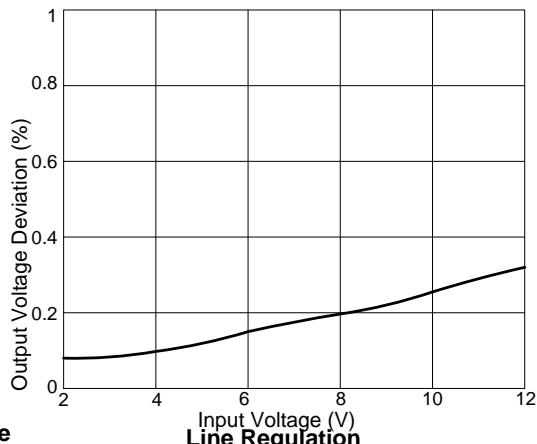
Dropout Voltage vs Output Current



Load Regulation vs Temperature

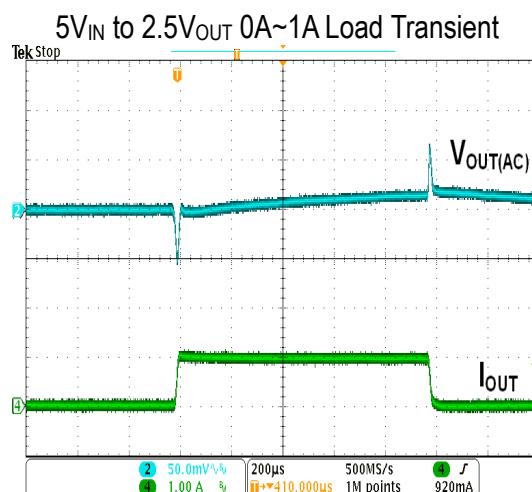
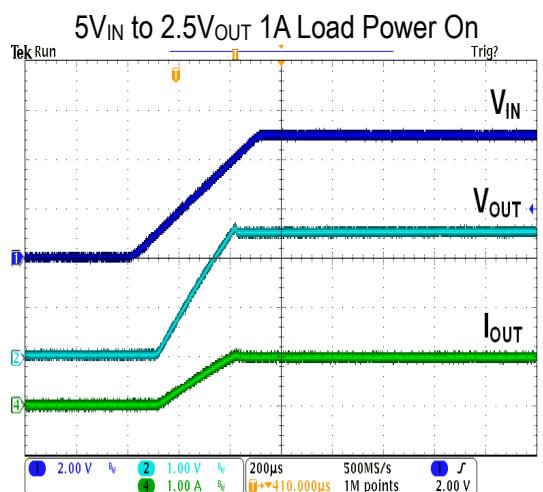
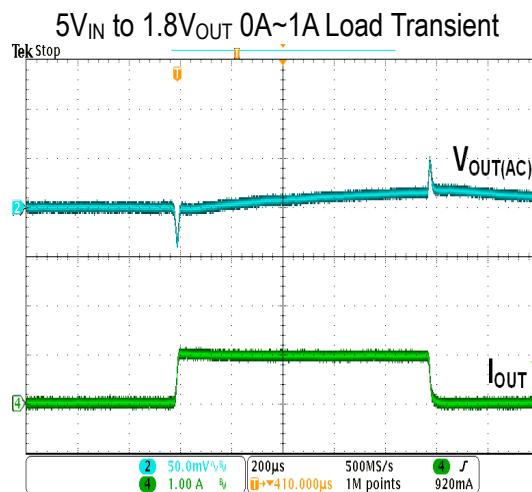
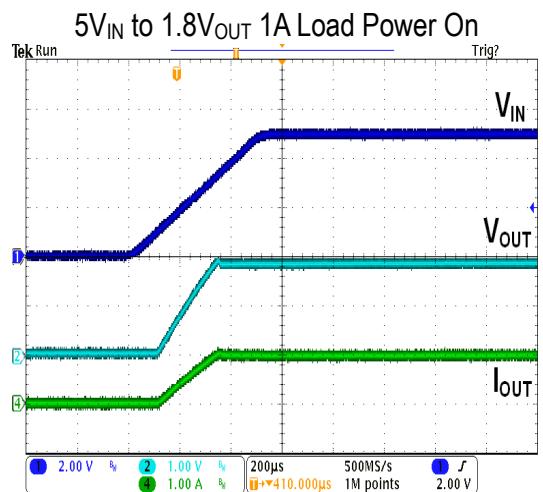
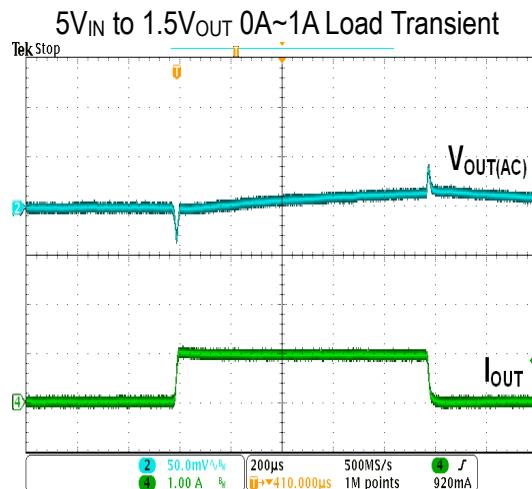
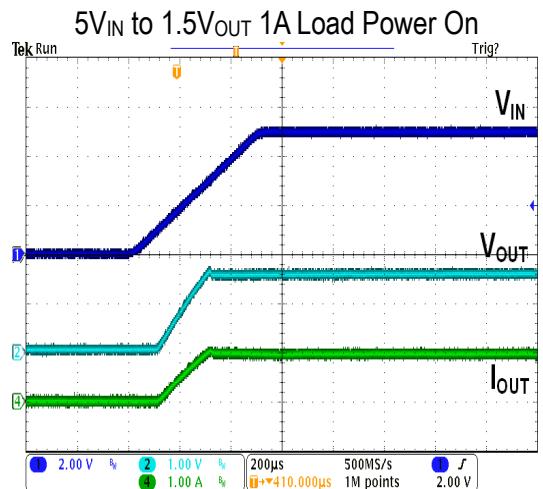


Percent Change in Output Voltage vs Temperature

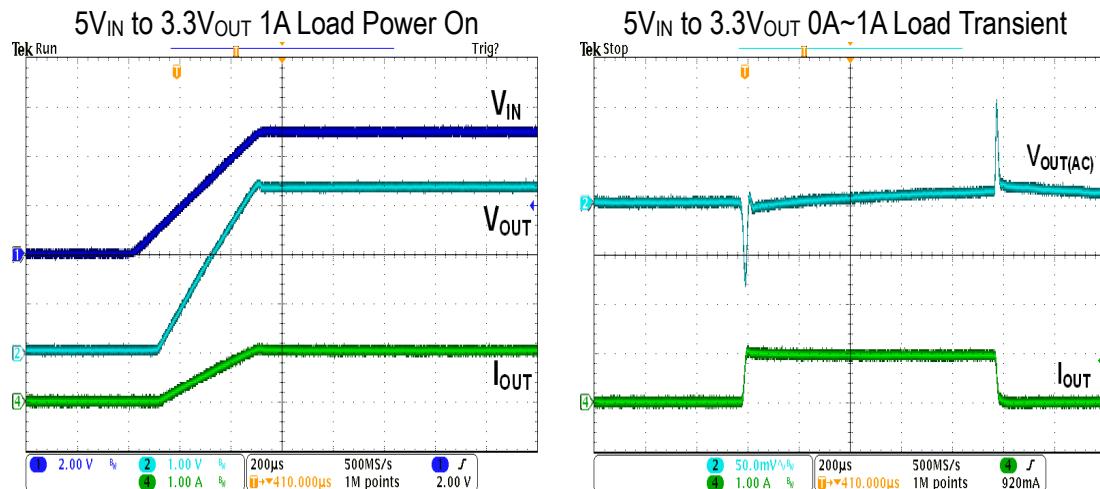


Line Regulation

❖ TYPICAL CHARACTERISTICS (CONTINUOUS)

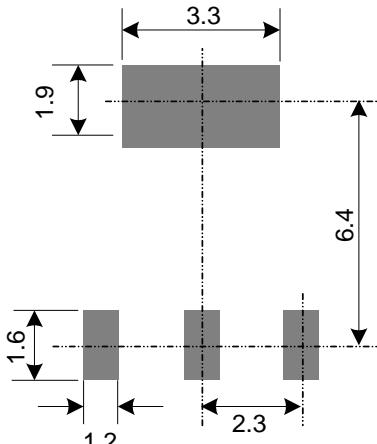
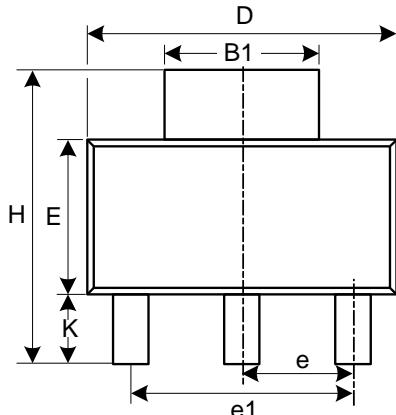


❖ TYPICAL CHARACTERISTICS (CONTINUOUS)

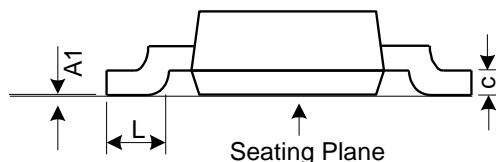
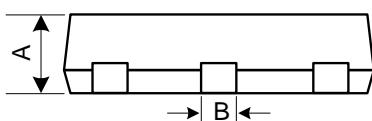


❖ PACKAGE OUTLINES

(1) SOT223-3L



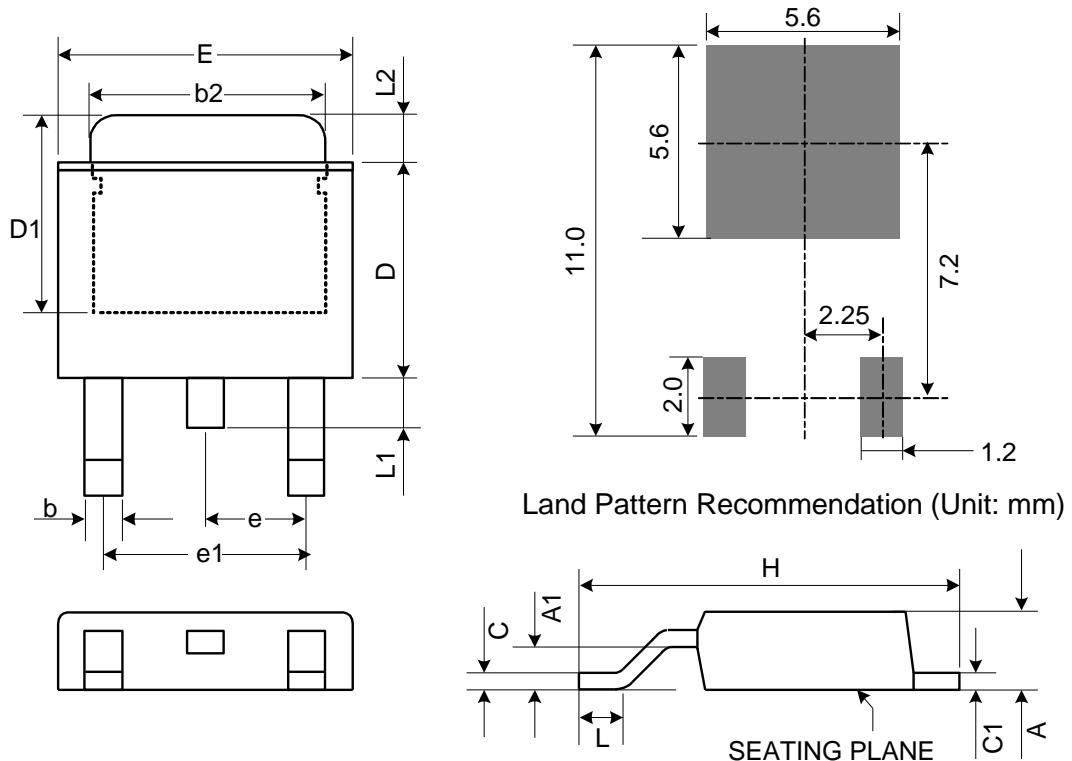
Land Pattern Recommendation (Unit: mm)



Symbol	Dimensions in Millimeters			Dimensions in Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	-	-	1.8	-	-	0.071
A1	0.02	0.06	0.1	0.001	0.002	0.004
B	0.66	0.75	0.84	0.026	0.03	0.033
B1	2.9	3	3.1	0.114	0.118	0.122
C	0.23	0.315	0.35	0.009	0.012	0.014
D	6.3	6.5	6.7	0.248	0.256	0.264
E	3.3	3.5	3.7	0.13	0.138	0.146
H	6.7	7	7.3	0.264	0.278	0.287
L	0.75	-	-	0.03	-	-
K	1.5	1.75	2	0.059	0.069	0.079
e	2.3 Basic			0.091 Basic		
e1	4.6 Basic			0.181 Basic		

JEDEC outline: TO-261 AB

(2) TO252-3L



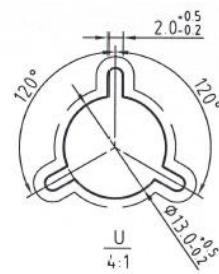
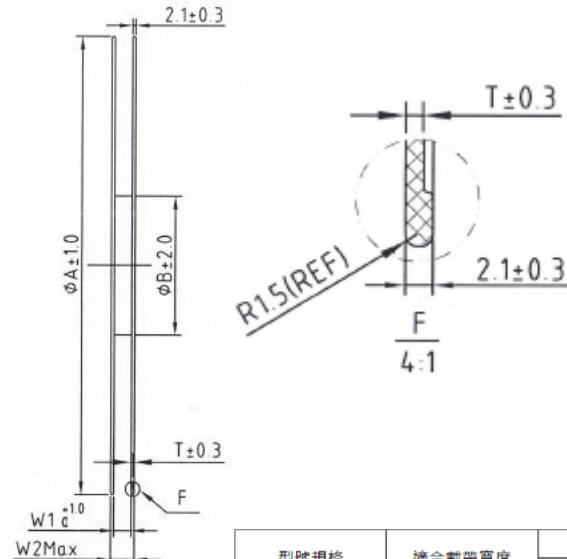
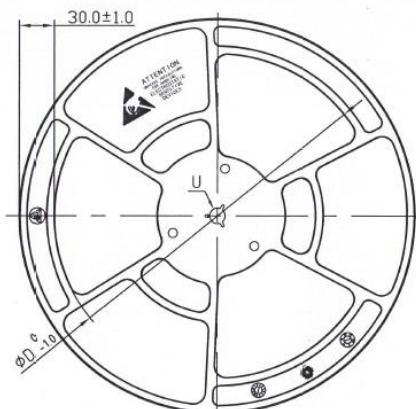
Symbol	Dimensions in Millimeters			Dimensions in Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	2.18	2.29	2.39	0.086	0.09	0.094
A1	-	-	0.13	-	-	0.005
b	0.51	0.71	0.89	0.02	0.028	0.035
b2	4.95	5.21	5.46	0.195	0.205	0.215
C	0.46	0.53	0.61	0.018	0.021	0.024
C1	0.46	0.53	0.58	0.018	0.021	0.023
D	5.33	5.46	5.59	0.21	0.215	0.22
D1	4.57	-	-	0.18	-	-
E	6.35	6.55	6.73	0.25	0.258	0.265
e	2.29 BSC			0.090 BSC.		
e1	4.58 BSC			0.180 BSC.		
H	9.4	9.7	10.4	0.37	0.382	0.41
L	1.4	1.6	1.78	0.055	0.063	0.07
L1	-	-	1.02	-	-	0.04
L2	1.52	1.78	2.03	0.06	0.07	0.08

Mold flash shall not exceed 0.005inch per side

JEDEC outline: TO-252 AB

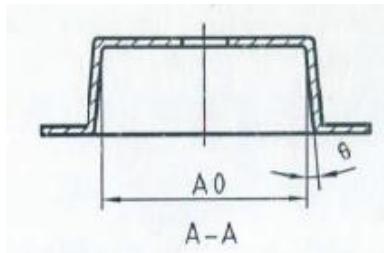
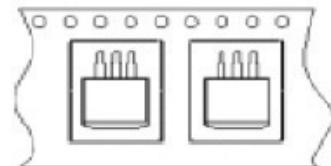
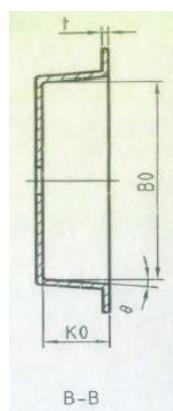
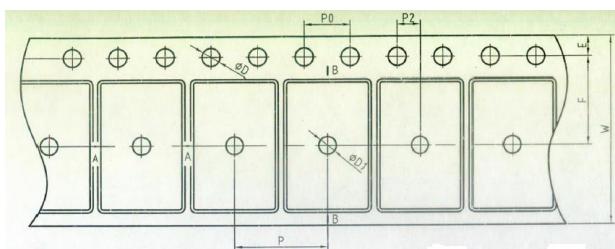
♦ Carrier tape dimension

TO-252-3L



型號規格	適合載帶寬度	圓盤基本尺寸				
		A	B(內徑)	W1	W2Max	T
13" - 12X100	12 / 12.2			12.4	18.4	
13" - 16X100	16			16.4	22.4	1.5
13" - 24X100	24			24.4	30.4	270

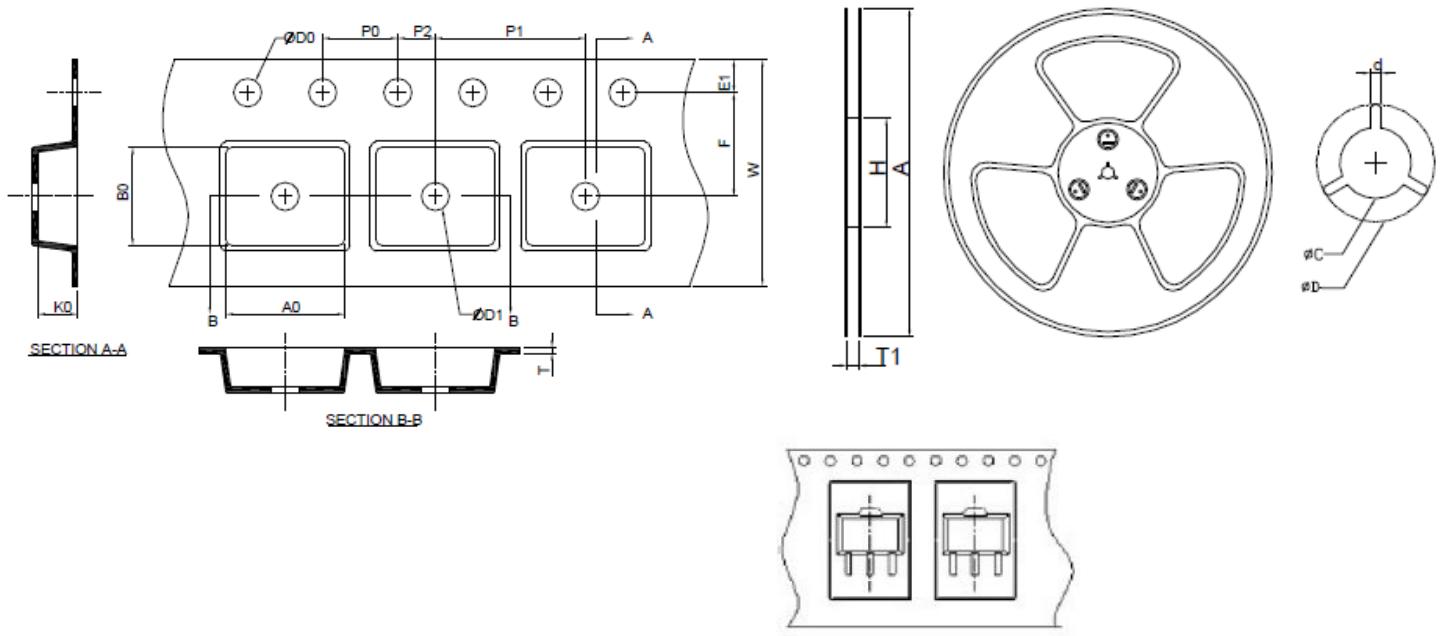
(mm)



E	F	P ₂	D	D ₁	P ₀	10P ₀
1.75±0.10	7.50±0.10	2.00±0.10	1.50 ^{+0.1} ₀	1.50 ^{+0.25} ₀	4.00±0.10	40.0±0.20
W	P	A ₀	B ₀	K ₀	t	θ

(mm)

SOT-223-3L



Application	A	H	T1	C	d	D	W	E1	F
SOT-223	320.0±2.00	50 MIN.	12.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	12.00±0.30	1.75±0.10	5.50±0.05
	P0	P1	P2	D0	D1	T	A0	B0	K0
	4.00±0.10	8.00±0.10	2.00±0.50	1.5+0.10 -0.00	1.5 MIN.	0.6+0.00 -0.40	6.90±0.20	7.50±0.20	2.10±0.20

Unit: mm